# swissbit®

**Product Data Sheet** 

## Industrial **SD / SDHC Memory Card**

### **S-600 Series** UHS-I Interface, SLC

### Standard and Extended Temperature Grade

Date: September 17, 2024 Revision: 1.04



Made in Germany

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## S-600 Series – Industrial SD/SDHC Memory Card, SLC 512 MBytes up to 32 GBytes

### **1. Product Summary**

- Capacities: 512 MBytes, 1 GBytes, 2 GBytes, 4 GBytes, 8 GBytes, 16 GBytes, 32 GBytes
- Form Factor: Standard SD Memory Card 32.0mm x 24.0mm x 2.1mm and Write Protect slider
- Compliance<sup>1</sup>: Fully compliant with SD Memory Card specification 5.0 (4-32GB) / 3.0 (512MB-2GB)
  - Up to speed class 10/U3/V30 according SD5.0 specification
  - Fully compatible with UHS-I/SDR104 hosts
  - $\circ$  SD2.0 SDHC backward compliant, default speed and high speed mode
  - o FAT16 / FAT32
  - Environmental: RoHS / REACH Compliant
- Compatibility: Support SD SPI mode
- Performance (max. capacity):
  - SD Default speed
    - SD High speed
    - SD UHS−I
    - Read performance: sequential read up to 95 MBytes/s
    - Write performance: sequential write up to 55 MBytes/s
- Operating Temperature Range:
  - Extended: -25 °C to 85 °C
  - Industrial: -40 °C to 85 °C
- Storage Temperature Range: -40 °C to 100 °C
- **Operating Voltage:** 2.7 ... 3.6V (Low-power CMOS technology)
- Data Retention: 10 Years @ Life Begin / 1 Year @ Life End
- Reliability:
  - Mean Time Between Failure (MTBF): > 3,000,000 hours
  - Number of insertions: up to 20,000
- **Shock/Vibration:** 1,500 *g* /50 *g*
- Electromagnetic Compatibility Test: Radiated Emission; Radiated Immunity; Electrostatic Discharge

<sup>&</sup>lt;sup>1</sup> The verification of host system and storage device compatibility is in customer's responsibility. Swissbit can provide guidance and support on request.

### 2. Product Features

- Optimized FW algorithms especially for read/write access, highest random write performance and best endurance with long data retention
  - Designed for usage in applications with highest requirements regarding reliability like data logging, POS/POI, Medical and other demanding use-cases
  - Especially suitable for intensive read/write operations
  - Advanced power-off reliability technology
  - Wear Leveling technology
     Equal wear leveling of static and dynamic data. The wear leveling assures that dynamic data as well as static data is balanced evenly across the memory. With that the maximum write endurance of the device is guaranteed
    - The S-600 series is optimized for high read/write traffic for demanding industrial applications.
    - Read Disturb Management
      - The read commands are monitored and the content is refreshed when critical levels have occurred
    - Data Care Management
       The interruptible background process maintain the user data for Read Disturb effects or Retention degradation due to high temperature effects
    - Near miss ECC technology
       Minimize the risk of uncorrectable bit failure over the product life time. Each read command analyzes the ECC margin level and refresh data if necessary
    - $\circ$   $\;$  Diagnostic features with Life Time Monitoring tool support
- High reliability
  - o SLC Flash
  - The product is optimized for long life cycle that requires good data retention because of high temperature mission profile
  - Number of card insertions/removals 20,000
  - o Industrial Temperature range -40° up to 85°C inclusive full cross temperature support<sup>2</sup>
  - SIP (System In Package) process for extreme dust, water and ESD proof
- Controlled "Locked" BOM & PCN process
- Manufactured in a TS 16949 certified factory
- Customized options like CID registers, CPRM keys, firmware incl. settings and marking on request
- In-field firmware update<sup>3</sup>
- Swissbit Device Manager (SBDM) Tool and SDK for SBDM (on request)



<sup>&</sup>lt;sup>2</sup> Cross temp. stability of 125 Kelvin: Feasible temperature difference between write/read of same data, e.g. write @-40°C, read @85°C.

## 3. Ordering Information

#### Table 1: Standard Product List

Constitut	Extended Temperature	Industrial Temperature
Capacity	Part Number	Part Number
512 MBytes	SFSD0512LgAS1T0-E-xx-2y1-STD	SFSD0512LgAS1T0-I-xx-2y1-STD
1 GBytes	SFSD1024LgAS1TO-E-xx-2y1-STD	SFSD1024LgAS1T0-I-xx-2y1-STD
2 GBytes	SFSD2048LgAS1TO-E-xx-2y1-STD	SFSD2048LgAS1T0-I-xx-2y1-STD
4 GBytes	SFSD4096LgAS1T0-E-xx-2y1-STD	SFSD4096LgAS1T0-I-xx-2y1-STD
8 GBytes	SFSD008GLgAS1T0-E-xx-2y1-STD	SFSDoo8GLgAS1T0-I-xx-2y1-STD
16 GBytes	SFSDo16GLgAS1TO-E-xx-2y1-STD	SFSD016GLgAS1T0-I-xx-2y1-STD
32 GBytes	SFSD032GLgAS1T0-E-xx-2y1-STD	SFSD032GLgAS1T0-I-xx-2y1-STD

g = product generation; xx = flash configuration; y = firmware revision

#### Table 2: Available Part Numbers

		ware 2
Capacity	Extended Temperature	Industrial Temperature
	Part Number	Part Number
512 MBytes	SFSD0512L1AS1TO-E-ME-221-STD	SFSD0512L1AS1T0-I-ME-221-STD
1 GBytes	SFSD1024L1AS1TO-E-DF-221-STD	SFSD1024L1AS1TO-I-DF-221-STD
2 GBytes	SFSD2048L1AS1TO-E-QG-221-STD	SFSD2048L1AS1TO-I-QG-221-STD
4 GBytes	SFSD4096L1AS1T0-E-ME-221-STD	SFSD4096L1AS1TO-I-ME-221-STD
8 GBytes	SFSD008GL1AS1T0-E-DF-221-STD	SFSD008GL1AS1T0-I-DF-221-STD
16 GBytes	SFSD016GL1AS1TO-E-QG-221-STD	SFSD016GL1AS1T0-I-QG-221-STD
32 GBytes	SFSD032GL1AS1TO-E-NG-221-STD	SFSD032GL1AS1T0-I-NG-221-STD

#### Table 3: Available Part Numbers

	Firmware 3		
Capacity	Extended Temperature	Industrial Temperature	
	Part Number	Part Number	
512 MBytes	SFSDo512L1AS1TO-E-ME-231-STD	SFSDo512L1AS1TO-I-ME-231-STD	
1 GBytes	SFSD1024L1AS1TO-E-DF-231-STD	SFSD1024L1AS1TO-I-DF-231-STD	
2 GBytes	SFSD2048L1AS1TO-E-QG-231-STD	SFSD2048L1AS1TO-I-QG-231-STD	
4 GBytes	SFSD4096L1AS1T0-E-ME-231-STD	SFSD4096L1AS1T0-I-ME-231-STD	
8 GBytes	SFSD008GL1AS1TO-E-DF-231-STD	SFSD008GL1AS1T0-I-DF-231-STD	
16 GBytes	SFSD016GL1AS1T0-E-QG-231-STD	SFSD016GL1AS1T0-I-QG-231-STD	
32 GBytes	SFSD032GL1AS1T0-E-NG-231-STD	SFSD032GL1AS1T0-I-NG-231-STD	

## **4. Product Description**

The SD Memory Card is a small form factor non-volatile memory card which provides high capacity data storage. Its aim is to capture, retain and transport data, audio and images, facilitating the transfer of all types of digital information between a large variety of digital systems.

The card operates in two basic modes:

- SD/SDHC and UHS-I card modes
- SPI mode

The SD Memory Card also supports SD Default and High Speed mode with up to 50MHz clock frequency as well as UHS-I modes.

The cards are compliant with

- SD Memory card Specification Part 1, Physical layer Specification V3.01 (5.00)
- SD Memory card Specification Part 2, File System Specification V3.00
- SD Memory card Specification Part 3, Security Specification V3.00
- SD Memory Card Addendum V4.oo
- Standard Size SD Card Mechanical Addendum Ver7.00

Simplified specifications are available at <a href="https://www.sdcard.org/">https://www.sdcard.org/</a>

The SD Card has an internal intelligent controller which manages interface protocols, data storage and retrieval as well as hardware BCH Error Correction Code (ECC), defect handling, diagnostics and clock control. The advanced wear leveling mechanism assures an equal usage of the Flash memory cells to extend the life time.

The hardware BCH-code ECC allows to detect and correct up to 24 defect bits per 1kByte.

The controller performs control read operations and checks the consistence of the data. If an error of some bits is detected, the card refreshes all data in the flash cells to prevent data retention problems.

The card has a power-loss management feature to prevent data corruption after power-down. The cards are RoHS compliant and lead-free.

### 4.1 Performance Specifications

System Performance		typ						Unit
	512MB	1GB	2GB	4GB	8GB	16GB	32GB	
Sequential Read	33	35	35	95	95	95	95	MD/a
Sequential Write	16	20	21	45	55	55	55	MB/s
Random Read 4k	850	850	850	1200	1200	1200	1200	10.00
Random Write 4k	1000	1100	1200	800	800	800	800	- IOPS
Speed class		10/U1			10/U	3/V30		-

#### Table 4: Read/Write Performance

The values are measured using Crystal Disk Mark 7.0.0 at 25°C. Performance depends on flash type and number, file/cluster size, and interface speed.

The cards use thermal management to ensure stability and reliability at high operating temperatures. Performance can be lower depending on ambient temperature and airflow.

### 4.2 Environmental Specifications

#### 4.2.1 Recommended Operating Conditions

The recommended operating conditions for the S-600 SD Memory Card are provided in Table 5 below.

#### Table 5: SD Memory Card recommended operation conditions

Parameter	Value <sup>4</sup>
Extended Operating Temperature	-25 °C to 85 °C
Industrial Operating Temperature	-40 °C to 85 °C

#### 4.2.2 Recommended Storage Conditions

The recommended storage conditions are listed below in Table 6.

#### Table 6: SD Memory Card recommended Storage Conditions

Parameter	Value⁵
Extended Storage Temperature	-25 °C to 100 °C
Industrial Storage Temperature	-40 °C to 100 °C

#### 4.2.3 Humidity & EMC

The humidity and EMC conditions are listed below in Table 7.

#### Table 7: Humidity & EMC

Parameter	Value
Humidity (Non-Condensing)	85% RH @85°C 1000h
ESD	up to ±4 kV (contact discharge), according to IEC61000-4-2 and SDA, Human Body Model 150pF/ 3300hm, on each contact pad, non-operating
	up to ±15 kV, (air discharge), according to IEC61000-4-2 and SDA, Human Body Model 150pF/ 3300hm, isolated contact pad area, non-operating

### 4.2.4 Environmental Conditions

Parameter	Value
UV light exposure	UV: 254nm, 15Ws/cm2 according to IS07816-1
X-Ray	0.1 Gy 70keV to 140KeV (IS07816-1) according SDA
Durability	20,000 mating cycles
Drop Test	1.5m free fall
Bending / Torque	10N / 0.15Nm ±2.5° max
Mechanical Shock	1500G, 0.5ms, half sine wave ±xyz-axis, 4 pulses each non-operating, JESD22B110/B104 Condition B
Vibration	50G, p-p, 202000Hz, sweep xyz-axis, 4 pulses each, non-operating, MIL-STD- 883 M2007.3 Condition B

<sup>&</sup>lt;sup>4</sup> High Temperature storage without operation reduces the data retention, in operation the data will be refreshed, if data error issues were detected.

<sup>&</sup>lt;sup>5</sup> High Temperature storage without operation reduces the data retention, in operation the data will be refreshed, if data error issues were detected.

### 4.3 Regulatory Compliance

The S-600 devices comply with the regulations / standards listed in Table 9.

Abbreviation	Regulation/ Standard			
ЕМС	CE – 2014/30/EU FCC – 47 CFR Part 15 UKCA – S.I. 2016 No. 1091 and S.I. 2012 No. 3032			
RoHS	2011/65/EU with 2015/863/EU and 2017/2102/EU			
REACh	1907/2006/EU and 207/2011/EU			
WEEE	2012/19/EU			

#### Table 9: Regulatory Compliance

### **4.4** Physical Dimensions

The physical dimensions of the S-600 SD Memory Card are listed in the following table.

#### Table 10: Measured Physical Dimensions

Physical Dimensions		Unit
Length	32.00±0.1	
Width	24.00±0.1	mm
Thickness (Max)	2.10±0.15	
Weight (Typ)	2	g

#### 4.5 Reliability

Table 11: Reliability			
Parameter	Value <sup>6</sup>		
Data Retention at beginning @ 40°C	10 years		
Data Retention at life end (100k PE cycles) @ 40°C	1 year		

<sup>&</sup>lt;sup>6</sup> After every 50 power on cycle the card reads the whole flash and performs a data refresh if necessary. So, the data retention can be much longer in most use cases.

### 4.6 Endurance

Endurance represented as TeraBytes Written (TBW) is provided in the following Table 12:

#### Table 12: Endurance<sup>7, 8</sup>

Capacity	TeraBytes Written (TBW) @ Seq. Write 1MB Operation	<b>TeraBytes Written (TBW)</b> @ Random Write 128kB Operation	<b>TeraBytes Written (TBW)</b> @ Random Write 4kB Operation
512 MBytes	53	21	4,3
1 GByte	106	31	7,1
2 GBytes	212	62	13,9
4 GBytes	425	128	27
8 GBytes	851	179	41
16 GBytes	1702	349	76
32 GBytes	3405	961	192

### 5. User density specification

The S-600 drive geometry is set to report industry standard LBA settings per the IDEMA standard (LBA1-03). The values for each capacity are shown below in Table 13.

Capacity	Total LBA	User Addressable Bytes
512 MBytes	967,680	495,452,160
1 GBytes	1,953,792	1,000,341,504
2 GBytes	3,938,304	2,016,411,648
4 GBytes	7,774,208	3,980,394,496
8 GBytes	15,802,368	8,090,812,416
16 GBytes	31,834,112	16,299,065,344
32 GBytes	62,333,952	31,914,983,424

#### Table 13: SD Memory Card capacity specification

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<sup>&</sup>lt;sup>7</sup> The specified TBW is valid, if the amount of data is spread evenly over at least 24 months. Higher daily data volume or frequent writing below o°C reduces the specified TBW. The drive endurance limit, also called EOL or o% remaining life, is defined as TBW or DWPD over the product's limited lifetime warranty period. TBW calculations refer to the JEDEC JESD218A and JESD219A standard for SSD device life and endurance measurement techniques if not otherwise specified.

<sup>&</sup>lt;sup>8</sup> Sequential write 1MB simulates a continuous stream recording on a drive which has been preconditioned with a sequential write of the complete drive, Random Write 128KB or 4KB represent data logging applications with large or small block sizes.

### 6. Card physical

The SD Memory Card contains a single chip controller and Flash memory module(s). The controller interfaces with a host system allowing data to be written to and read from the Flash memory module(s).

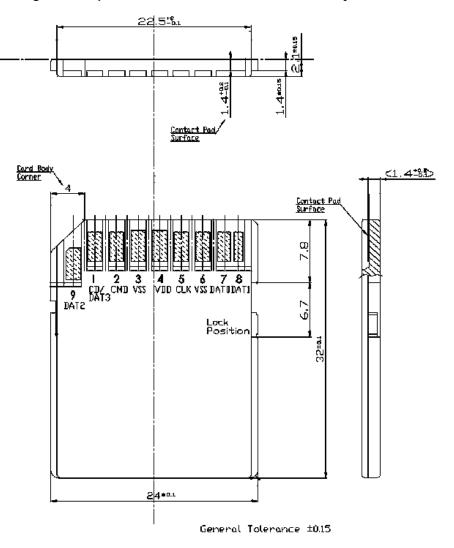


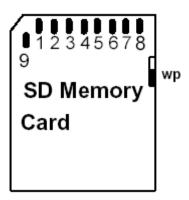
Figure 1: Simplified mechanical dimensions SD Memory Card

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## 7. Electrical interface

### 7.1 Electrical description

Figure 2: SD Memory Card shape and interface (Bottom view)



#### Table 14: Pad assignment – SD Mode

Pin		SD Mode			
	Name	Туре <sup>9</sup>	Description		
1	CD/DAT3 <sup>10</sup>	I/0/PP <sup>11</sup>	Card Detect/ Data Line [Bit 3]		
2	CMD	РР	Command/Response		
3	VSS1	S	Supply voltage ground		
4	VDD	S	Supply voltage		
5	CLK	I	Clock		
6	VSS2	S	Supply voltage ground		
7	DATo	I/0/PP	Data Line [Bit o]		
8	DAT1 <sup>12</sup>	I/0/PP	Data Line [Bit 1]		
9	DAT2 <sup>13</sup>	I/O/PP	Data Line [Bit 2]		

#### Table 15: Pad assignment – SPI Mode

Pin		SPI Mode	
	Name	Туре <sup>9</sup>	Description
1	CS	<sup>11</sup>	Chip Select (neg true)
2	DI		Data In
3	VSS	S	Supply voltage ground
4	VDD	S	Supply voltage
5	SCLK	I	Clock
6	VSS2	S	Supply voltage ground
7	DO	0/PP	Data Out
8	RSV		
9	RSV		

<sup>&</sup>lt;sup>9</sup> S: power supply; I: input; O: output using push-pull drivers; PP: I/O using push-pull drivers

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<sup>&</sup>lt;sup>10</sup> The extended DAT lines (DAT1-DAT3) are input on power up. They start to operate as DAT lines after SET\_BUS\_WIDTH command.

The Host shall keep its own DAT1-DAT3 lines in input mode, as well, while they are not used.

<sup>&</sup>lt;sup>11</sup> At power up this line has a 50k0hm pull up enabled in the card. This resistor serves two functions Card detection and Mode Selection. For Mode Selection, the host can drive the line high or let it be pulled high to select SD mode. If the host wants to select SPI mode it should drive the line low. For Card detection, the host detects that the line is pulled high.

This pull-up should be disconnected by the user, during regular data transfer, with SET\_CLR\_CARD\_DETECT (ACMD42) command<sup>12</sup> DATI line may be used as Interrupt Output (from the Card) in SDIO mode during all the times that it is not in use for data transfer

operations (refer to "SDIO Card Specification" for further details).

<sup>&</sup>lt;sup>13</sup> DAT2 line may be used as Read Wait signal in SDIO mode (refer to "SDIO Card Specification" for further details).

#### 7.2 Power up / Power down behavior and reset

#### 7.2.1 Power up

The host can start with communication 1ms after 2.7V is reached according the SDA specification. That should perform 74 clock cycles and start with the sequence CMDo, CMD8, ACMD41 until card is ready as described in the SD specification 3.00.

#### 7.2.2 Power down

When the power falls below 2.6V the controller stops the communication to the flash, but enables the flash to finish a started flash program operation (if voltage drop is not fast).

After next initialization the controller checks the last written data for consistency and refreshes the data. Either the new or the old data (if the write operation could not be finished) are available.

#### 7.2.3 Power drop

If the voltage drops below 2.6V and rises again, the card performs a reset. The card must be initialized like after a power on.

#### 7.2.4 Operation below minimum voltage

#### 512MB-2GB

If the card is initialized from the host (ACMD41) below 2.7V the card may not be recognized.

#### 4GB-32GB

If the card initialization is performed below the specified voltage of 2.7V, the card may be detected as 1MB card with no useful data. In this case the host should power off and on the card and start initialization above 2.7V.

### 7.3 DC characteristics

Measurements are at recommended Operating Conditions unless otherwise specified.

Symbol	Parameter	Density	Min	Тур	Мах	Unit	Notes
I <sub>DD</sub>	Operating Current Read	512MB		75	80	mA	@ 25°C
I <sub>DD</sub>	(SDR50 max. 2GB	1GB-2GB		80	85	mA	@ 25°C
I <sub>DD</sub>	SDR104 >2GB)	4GB-32GB		125	135	mA	@ 25°C
I <sub>DD</sub>		512MB		75	80	mA	@ 25°C
I <sub>DD</sub>	Operating Current Write (SDR50 max. 2GB	1GB-2GB		95	100	mA	@ 25°C
I <sub>DD</sub>	SDR104 >2GB	4GB		100	105	mA	@ 25°C
I <sub>DD</sub>		8GB-32GB		120	130	mA	@ 25°C
I <sub>DD</sub>	Dackground road and refresh <sup>15</sup>	512MB-2GB		80	100	mA	@ 25°C
I <sub>DD</sub>	Background read and refresh <sup>15</sup>	4GB-32GB		105	120	mA	@ 25°C
I <sub>DD</sub>	Pre-initialization Standby Current			5	15	mA	@ 25°C
I <sub>DD</sub>	Post-initialization Standby Current <sup>16</sup>			10	12	mA	@ 25°C
I <sub>DD</sub>	Post-initialization Standby Current <sup>17</sup>			10	12	mA	@ 25°C
ILI	Input Leakage Current		-2		2	μA	without pull up R
I <sub>LO</sub>	Output Leakage Current		-2		2	μA	without pull up R

#### Table 17: SD Memory Card Recommended Operating Conditions

Symbol	ool Parameter		min	typ	max	unit
V <sub>DD</sub>	Supply Voltage Normal Operating Status		2.7	3.3	3.6	V
-	Power Up Time (from oV to VDD min)				250	ms

<sup>&</sup>lt;sup>14</sup> Target values

<sup>&</sup>lt;sup>15</sup> The card can perform auto data read of the whole card to check for ECC errors and performs data refresh

<sup>&</sup>lt;sup>16</sup> Before auto read the idle current is larger than the typical idle current after auto read

### 7.4 Signal Loading

According to SD specification

### 7.5 AC characteristics

#### 7.5.1 Default Speed mode (0–25MHz)

According to SD specification

#### 7.5.2 High Speed mode (0-50MHz)

According to SD specification

#### 7.5.3 UHS modes

UHS modes were driven with a signal level of 1.8V. The cards support following UHS-I modes:

#### Table 18: Supported UHS-I modes for max. 2GB cards

Host request	Card Modes (to select by host)	Max. Burst MB/s	Max. Clock frequency MHz
SDR12	SDR12	up to 12.5	up to 25
SDR25	SDR12, SDR25	up to 25	up to 50
SDR50	SDR12, SDR25, SDR50	up to 50	up to 100
DDR50	SDR12, SDR25, SDR50, DDR50	up to 50	50 (rising and falling edge)
SDR104	SDR12, SDR25, SDR50, DDR50	up to 50	up to 100

#### Table 198: Supported UHS-I modes for >2GB cards

Host request	Card Modes (to select by host)	Max. Burst MB/s	Max. Clock frequency MHz
SDR12	SDR12	up to 12.5	up to 25
SDR25	SDR12, SDR25	up to 25	up to 50
SDR50	SDR12, SDR25, SDR50	up to 50	up to 100
DDR50	SDR12, SDR25, SDR50, DDR50	up to 50	50 (rising and falling edge)
SDR104	SDR12, SDR25, SDR50, DDR50, SDR104	up to 104	up to 208

According to SD specification

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### 8. Host access specification

The following chapters summarize how the host accesses the card:

- Chapter 8.1 summarizes the SD and SPI buses.
- Chapter 8.2 summarizes the registers.

### 8.1 SD and SPI Bus Modes

The card supports SD and the SPI Bus modes. Application can chose either one of the modes. Mode selection is transparent to the host. The card automatically detects the mode of the reset command and will expect all further communication to be in the same communication mode. The SD mode uses a 4-bit high performance data transfer, and the SPI mode provides compatible interface to MMC host systems with little redesign, but with a lower performance.

#### 8.1.1 SD Bus Mode Protocol

The SD Bus mode has a single master (host) and multiple slaves (cards) synchronous topology. Clock, power, and ground signals are common to all cards. After power up, the SD Bus mode uses DATo only; after initialization, the host can change the cards' bus width from 1 bit (DATo) to 4 bits (DATo-DAT3). In high speed mode, only one card can be connected to the bus.

Communication over the SD bus is based on command and data bit streams which are initiated by a start bit and terminated by a stop bit.

- Command: a command is a token which starts an operation. A command is sent from the host either to a single card (addressed command) or to all connected cards (broadcast command). A command is transferred serially on the CMD line.
- Response: a response is a token which is sent from an addressed card, or (synchronously) from all connected cards, to the host as an answer to a previously received command. A response is transferred serially on the CMD line.
- Data: data can be transferred from the card to the host or vice versa. Data is transferred via the data lines.

#### 8.1.2 SPI Bus Mode Protocol

The Serial Peripheral Interface (SPI) Bus is a general purpose synchronous serial interface. The SPI mode consists of a secondary communication protocol. The interface is selected during the first reset command after power up (CMDo) and it cannot be changed once the card is powered on.

While the SD channel is based on command and data bit streams which are initiated by a start bit and terminated by a stop bit, the SPI channel is byte oriented. Every command or data block is built of 8-bit bytes and is byte aligned to the CS signal.

The card identification and addressing methods are replaced by a hardware Chip Select (CS) signal. There are no broadcast commands. For every command, a card (slave) is selected by asserting (active low) the CS signal.

The CS signal must be continuously active for the duration of the SPI transaction (command, response and data). The only exception occurs during card programming, when the host can de-assert the CS signal without affecting the programming process.

The bidirectional CMD and DAT lines are replaced by unidirectional dataIn and dataOut signals.

#### Table 20: SPI Bus Signals

Signal	Description
/CS	Host to card chip select
CLK	Host to card clock signal
Data In	Host to card data signal
Data Out	Card to host data signal
Vdd, Vss	Power and ground

#### 8.1.3 Mode Selection

The SD Memory Card wakes up in the SD mode. It will enter SPI mode if the CS signal is asserted (negative) during the reception of the reset command (CMDo) and the card is in idle\_state. If the card recognizes that the SD mode is required it will not respond to the command and remain in the SD mode.

If SPI mode is required the card will switch to SPI and respond with the SPI mode R1 response. The only way to return to the SD mode is by entering the power cycle. In SPI mode the SD Memory Card protocol state machine is not observed. All the SD Memory Card commands supported in SPI mode are always available.

During the initialization sequence, if the host gets Illegal Command indication for ACMD41 sent to the card, it may assume that the card is Multimedia Card. In that case it should re-start the card as Multimedia Card using CMDo and CMD1.

### 8.2 Card registers

The SD Memory Card has the following registers.

Register name	Bit width	Description	Function
CID	128	Card Identification information	This register contains the card identification information used during the Card Identification phase.
OCR	32	Operation Conditions Registers	This register describes the operating voltage range and contains the status bit in the power supply.
CSD	128	Card specific information	This register provides information on how to access the card content. Some fields of this register are writeable by PROGRAM_CSD (CMD27).
SCR	64	SD Memory Card's Special features	This register provides information on special features.
RCA <sup>17</sup>	16	Relative Card Address	This register carries the card address is SD Card mode.
SSR	512	SD Status	information about the card proprietary features and vendor specific life time information

#### Table 21: SD Memory Card registers

#### Table 22: CID registers

Register name	Bit width	Description	Function
MID	8	Manufacture ID	0x5d
OID	16	0EM/Application ID	0X5342
PNM	40	Product Name	SB PNM Naming
PRV	8	Product Revision	oxgg
PSN	32	Product Serial Number	XXXXXXXX
-	4	Reserved	0X0
MDT	12	Manufacture Date	охуут
CRC	7	Check sum of CID contents	chksum
-	1	Not used; always=1	1



<sup>&</sup>lt;sup>17</sup> RCA register is not available in SPI mode

#### Table 23: OCR register

OCR bit positon	VDD voltage windows	Typ. value	OCR bit position	VDD voltage window	Typ. value
0-3	Reserved	0	15	2.7-2.8	1
4	1.6-1.7	0	16	2.8-2.9	1
5	1.7-1.8	0	17	2.9-3.0	1
6	1.8-1.9	0	18	3.0-3.1	1
7	1.9-2.0	0	19	3.1-3.2	1
8	2.0-2.1	0	20	3.2-3.3	1
9	2.1-2.2	0	21	3.3-3.4	1
10	2.2-2.3	0	22	3.4-3.5	1
11	2.3-2.4	0	23	3.5-3.6	1
12	2.4-2.5	0	24	Switching to 1.8V accepted	1
13	2.5-2.6	0	25-29	Reserved	
14	2.6-2.7	0	30	Card Capacity Status (CCS)	*18
			31	o=busy; 1=ready	*19

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 $<sup>^{\</sup>rm 18}$  This bit is valid only when the card power up status bit is set

<sup>&</sup>lt;sup>19</sup> This bit is set to LOW if the card has not finished the power up routine

#### Table 24: CSD register

Register name	Bits	Bit width	Description	Typ. value (max. 2GB)	Typ. value (>2GB)
CSD_STRUCTURE	127:126	2	CSD structure	00	01
_	125:120	6	Reserved	Reserved 00000	
TAAC	119:112	8	Data read access time 1	00101111	00001110
NSAC	111:104	8	Data read access time 2 (CLK cycle)	0000000	0000000
TRAN_SPEED	103:96	8	Data transfer rate	00110010 Default speed 00001011 SDR 50 or other values	00110010 Default speed 00001011 SDR 50 or other values
CCC	95:84	12	Card command classes	010111110101	010110110101
READ_BL_LEN	83:80	4	Read data block length	1001	1001
READ_BL_PARTIAL	79	1	Partial blocks for read allowed	1	0
WRITE_BLK_MISALIGN	78	1	Write block misalignment	0	0
READ_BLK_MISALIGN	77	1	Read block misalignment	0	0
DSR_IMP	76	1	DSR implemented	0	0
_	75:74	2	Reserved	00	-
C_SIZE	73:62	12	Device size	Device size xxx <sup>20</sup>	
VDD_R_CURR_MIN	61:59	3	VDD min read current	111	-
VDD_R_CURR_MAX	58:56	3	VDD max read current	111	-
VDD_W_CURR_MIN	55:53	3	VDD min write current	111	-
VDD_W_CURR_MAX	52:50	3	VDD max write current	111	-
C_SIZE_MULT	49:47	3	Device size multiplier	111 <sup>20</sup>	-
-	75:70	6	Reserved	-	000000
C_SIZE	69:48	22	Device size	-	XXX <sup>20</sup>
_	47	1	Reserved	-	0
ERASE_BLK_EN	46	1	Erase single block enable	1	1
SECTOR_SIZE	45:39	7	Erase sector size	1111111	1111111
WP_GRP_SIZE	38:32	7	Write protect group size	000000	0000000
WP_GRP_ENABLE	31	1	Write protect group enable	1	0
_	30:29	2	Reserved	00	00
R2W_FACTOR	28:26	3	Write speed factor	Write speed factor 010	
WRITE_BL_LEN	25:22	4	Write data block length	1001 <sup>20</sup>	1001 <sup>20</sup>
WRITE_BL_PARTIAL	21	1	Partial blocks for write allowed	0	0

<sup>&</sup>lt;sup>20</sup> Drive size and block sizes vary with card capacity

_	20:16	5	Reserved	00000	00000
FILE_FORMAT_GRP	15	1	File format group	0 W(1)	0 W(1)
СОРҮ	14	1	Copy flag	0 W(1)	0 W(1)
PERM_WRITE_PROTECT	13	1	Permanent write protection	o W(1)	o W(1)
TMP_WRITE_PROTECT	12	1	Temporary write protection	o W	o W
FILE_FORMAT	11:10	2	File format	00 W(1)	00 W(1)
-	9:8	2	Reserved	oo W	oo W
CRC	7:1	7	Checksum of CSD contents	xxxxxx W	xxxxxx W
-	0	1	Always=1	1	1

≤2GB

memory capacity = BLOCKNR \* BLOCK\_LEN Where BLOCKNR = (C\_SIZE+1) \* MULT MULT =  $2^{C_SIZE_MULT+2}$  (C\_SIZE\_MULT < 8) BLOCK\_LEN =  $2^{READ_BL_LEN}$ , (READ\_BL\_LEN < 12)

>2GB memory capacity = (C\_SIZE+1) \* 512kByte

 W
 value can be changed with CMD27 (PROGRAM\_CSD)

 W(1)
 value can be changed ONCE with CMD27 (PROGRAM\_CSD)

#### Table 25: SCR register

Field	Bits	Bit width	Typ. value	Remark
SCR_STRUCTURE	63:60	4	0000	SCR 1.012.00
SD_SPEC	59:56	4	0010	SD 2.0 or 3.0
DATA_STAT_AFTER_ERASE	55	1	1	data are oxFF after erase
SD_SECURITY	54:52	3	010 011	1.01 (SDSC) 2.00 (SDHC)
SD_BUS_WIDTHS	51:48	4	0101	1 or 4 bit
SD_SPEC3	47	1	1	yes→ >= SD3.0
EX_SECURITY	46:43	4	0000	no extended security
SD_SPEC4	42:42	1	0 / 1	no / yes
SD_SPECX	41:38	4	0 / 1	Version 3.xx / Version 5.x
Reserved	37:36	9	0	
CMD_SUPPORT	35:32	2	00 11	CMD23 CMD20 not supported CMD23 CMD20 supported

#### Table 26: RCA register

Field	Bits	Bit width
RCA	16	0X0000 <sup>21</sup>

<sup>&</sup>lt;sup>21</sup> After initialization the card can change the RCA register

#### Table 27: SSR register

Field	Bits	Bit width	Typ. value	Remark
Data bus width	511:510	2	0X2 <sup>22</sup>	4 bit width
Secured mode	509:509	1	0X0	not secured
Reserved for security	508:502	7	0X00	-
Reserved	501:496	6	0X00	-
SD card type	495:480	16	0X0000	Regular SD
Size protected area	479:448	32	0x02800000 0x05000000	40MB 80MB
Speed class	447:440	8	0X04	Class 10
Move performance	439:432	8	0X05	5 MB/s sequential write
Allocation unit size	431:428	4	0X7 0X9	1 MiB 4 MiB
Reserved	427:424	4	0X0	
Erase unit size	423:408	16	0X0001	1 AU
Erase unit timeout	407:402	6	0X01	1 second
Erase unit offset	401:400	2	0X1	1 seconds
UHS mode Speed Grade	399:396	4	0x1 / 0x3	UHS Grade 1 / 3
Allocation unit size in UHS mode	395:392	4	0X7 0X9	1 MiB 4 MiB
Reserved	391:312	80		
Data structure version identifier, currently 1	311:304	8	0X01	version 1
Number of manufacturer marked defect blocks	303:288	16	0X0008	8 initial BB
Number of initial spare blocks (worst chip)	287:272	16	oxoobf	191 spare blocks
Number of initial spare blocks (sum over all chips)	271:256	16	0X017e	382 spare blocks
Percentage of remaining spare blocks (worst chip)	255:248	8	0x64 <sup>22</sup>	100%
Percentage of remaining spare blocks (all chips)	247:240	8	0x64 <sup>22</sup>	100%
Number of uncorrectable ECC errors (not including ECC errors during startup)	239:224	16	0X0000 <sup>22</sup>	o uncorrectable errors
Number of correctable ECC errors (not including ECC errors during startup)	223:192	32	0X0045074b <sup>22</sup>	4523851 correctable ECC error
Lowest wear level class	191:176	16	0X0000 <sup>22</sup>	0
Highest wear level class	175:160	16	0X0000 <sup>22</sup>	0
Wear level threshold	159:144	16	0x01ff	512 block erases per WL class
Total number of block erases	143:96	48	0X001ff0 <sup>22</sup>	8176 block erase commands
Number of flash blocks, in units of 256 blocks	95:80	16	0X0020	8192 flash blocks
Maximum flash block erase count target, in wear level class units	79:64	16	0X0075	Flash endurance 117 WL classe (59904 erases)
Power on count	63:32	32	0X0000003 <sup>22</sup>	3x power on
Firmware version	31:0	32	oxYYMMDDXX	Firmware version

Bit 311:0 are vendor specific, example values in the table

<sup>&</sup>lt;sup>22</sup> Value change in operation

## 9. Life Time Monitoring

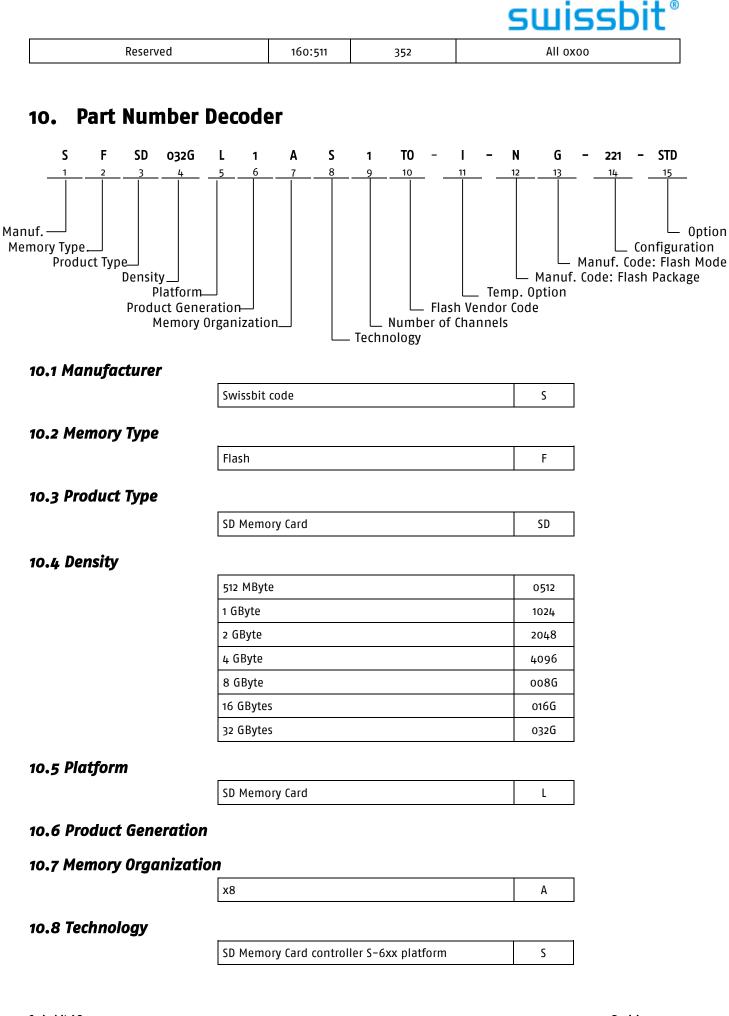
The products support life time monitoring with a vendor specific SD command CMD56 with argument 0x53420001 (read transfer). CMD56 follows the SD protocol specification and returns 512 bytes of data. All multi-byte values are in big endian order (most significant byte first).

Table	28:	Life	Time	Monitoring
14010				- I O I I CO I I I O

Field	Bytes	Byte width	Remark
Unique ID	0:15	16	53 77 69 73 73 62 69 74 «Swissbit» in ASCII
SD CID Register	16:31	16	See chapter 8.2
Firmware Revision	32:42	11	ASCII Null-Terminated
Reserved	43:47	5	All oxoo
User Area Rated Cycles	48:51	4	
User Area Max. Cycle Count	52:55	4	
User Area Total Cycle Count	56:59	4	
User Area Average Cycle Count	60:63	4	
Reserved	64:79	16	All oxoo
Remaining Card Lifetime Percent (user area)	80:80	1	
Reserved	81:85	5	All οχοο
Current SD Card Speed Mode	86:86	1	oxoo: Default Speed oxo1: High Speed ox10: SDR12 ox11: SDR25 ox12: SDR50 ox14: DDR50 ox18: SDR104
Current SD Card Bus Width	87:87	1	oxoo: 1 bit width ox1o: 4 bit width
Initial Spare Blocks User Area	88:91	4	
Reserved	92:95	4	All oxoo
Runtime Bad Blocks User Area	96:99	4	
Reserved	100:103	4	All oxoo
Refresh Count User Area	104:107	4	
Reserved	108:111	4	All oxoo
Host Interface CRC count	112:115	4	
Power Cycle Counter	116:119	4	
Read Count Threshold User Area	120:123	4	
Reserved	124:127	4	
Near Miss Count in User Area Blocks	128:131	4	
Reserved	132:143	12	All oxoo
Number of Firmware Refreshes	144:147	4	
Reserved	148:150	3	All oxoo
Auto Refresh	151:151	1	oxoo: disabled oxo1: enabled
Total number of blocks scanned during Auto Refresh	152:155	4	
Total number of blocks refreshed by Auto Refresh	156:159	4	

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#### 10.9 Channels 1 Flash channel 1 10.10 Flash Code Toshiba / Kioxia T0 10.11 Temperature Option Extended Temperature Range: -25 °C to 85 °C Е Industrial Temperature Range: -40 °C to 85 °C Т 10.12 Die Classification SLC MONO (single die package) М SLC DDP (dual die package) D SLC QDP (quad die package) Q SLC ODP (octal die package) Ν 10.13 Pin Mode Single nCE and Single R/nB Ε F Dual nCE and Dual R/nB Quad nCE and Quad R/nB G 10.14 Configuration XYZ X = Configuration Configuration Х UHS-I 2 Y = Firmware Revision FW Revision Y Firmware 2 2 Firmware 3 3 Z = Optional **Optional** Ζ **Optional** 1 10.15 Option Swissbit/Standard STD

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## 11. Marking specification

### 11.1 Front side



11.2 Back side marking



SWISSBIT SFSDXXXLXAS1 TO-X-XX-XXX-STD 5021-6131210X Made in Germany CE WEEE

Part– number Calendar week and year – Lot code

Example of the back side laser marking



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### 12. Revision History

#### Table 29: Document Revision History

Date	Revision Description		Revision Details
13-April-2022	1.00	Initial release	Doc. req. no. 5366
22-April-2022	1.01	Adjusted Performance values of 512MB-2GB	Doc. req. no. 5380
15-August-2022	1.02	Updated to firmware "2"	Doc. req. no. 5678
16-August-2024	1.03	Firmware 3 Products have been added	P000000787
17-September-2024	1.04	Firmware 3 Products have been added (4GB to 32GB) Corrected values for "System Area Cycle Count" on table 28 (new values =0)	

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